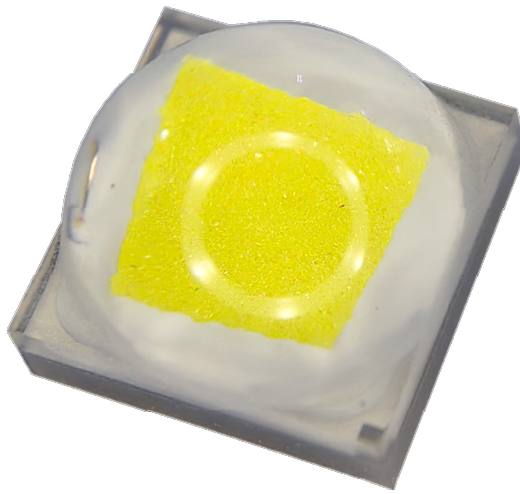


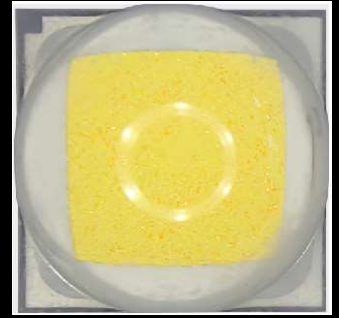


Bridgelux® SMD 3535 2W/3V Series

Product Data Sheet DS893

Introduction

SMD 3535



Features

- Package: SMT ceramic package with silicone lens
- Lumen maintenance: Test results according to IESNA LM-80 available
- ESD8kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012
- Operates at a maximum current of up to 1.8A
- Hot binning @ 85 °C

Application

- Indoor Lighting: Spotlight, Downlight
- Outdoor Lighting: Street Light, Tunnel Light, Security Light, Area Light, Stadium/Arena Light
- Industrial Lighting: High Bay Light, Low Bay Light
- Consumer Lighting: Torch Light

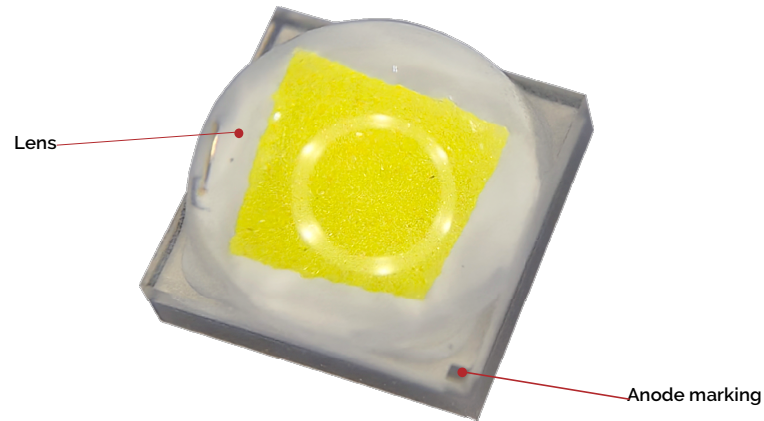
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Product Feature Map

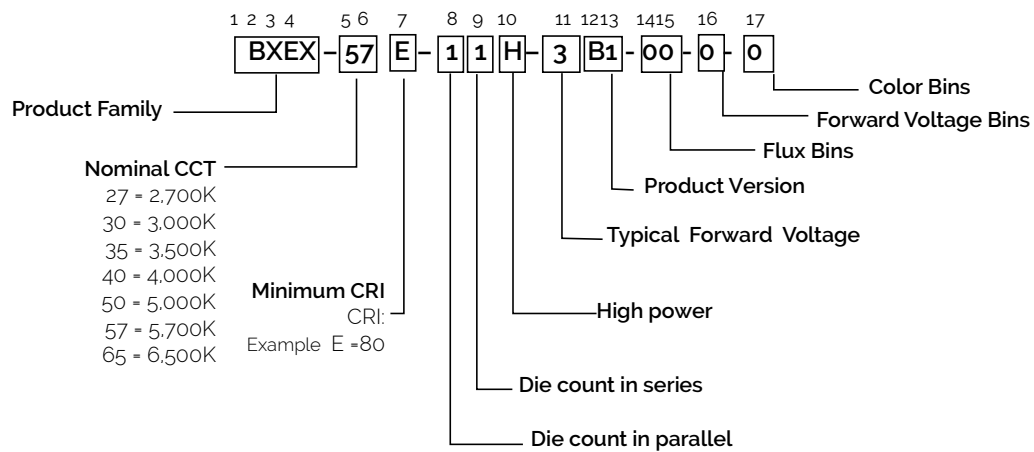
Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance.

helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting



Product Nomenclature

The part number designation for Bridgelux SMD 3535 is explained as follows:



Product Test Conditions

Bridgelux SMD 3535 LEDs are tested and binned with a 10ms pulse of 700mA at T_j (junction temperature) = T_{sp} (solder point temperature) = 85°C. Luminous flux, color and forward voltage are binned at $T_j = T_{sp} = 85^\circ\text{C}$.

Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 700mA ($T_j = T_{sp} = 25^\circ\text{C}$)

Part Number ^{1,6}	Nominal CCT ² (K)	CRI ^{3,5}	Nominal Drive Current (mA)	Forward Voltage ^{4,5} (V)			Typical Pulsed Flux ^{4,5} (lm)	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEX-27E-11H-3B1-00-0-0	2700	80	700	2.80	2.88	3.10	320	2.02	159
BXEX-30E-11H-3B1-00-0-0	3000	80	700	2.80	2.88	3.10	340	2.02	169
BXEX-35E-11H-3B1-00-0-0	3500	80	700	2.80	2.88	3.10	350	2.02	174
BXEX-40E-11H-3B1-00-0-0	4000	80	700	2.80	2.88	3.10	370	2.02	184
BXEX-50E-11H-3B1-00-0-0	5000	80	700	2.80	2.88	3.10	370	2.02	184
BXEX-57E-11H-3B1-00-0-0	5700	80	700	2.80	2.88	3.10	370	2.02	184
BXEX-65E-11H-3B1-00-0-0	6500	80	700	2.80	2.88	3.10	350	2.02	174

Notes for Table 1 :

- The last 6 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and color bin.
- Example: BXEX-57E-11H-3B1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 5700K 6-step ANSI standard chromaticity region with a minimum of 80 CRI, 1x1 die configuration, high power, 2.88V typical forward voltage.
- Product CCT is hot targeted at $T_{sp} = 85^\circ\text{C}$. Nominal CCT as defined by ANSI C78.377-2011.
- Listed CRIs are minimum values and include test tolerance.
- Products tested under pulsed condition (10ms pulse width) at nominal drive current.
- Bridgelux maintains a $\pm 7.5\%$ tolerance on luminous flux measurements, $\pm 0.15\text{V}$ tolerance on forward voltage measurements, and ± 2 tolerance on CRI measurements for the SMD 3535.
- Refer to Table 6 and Table 7 for Bridgelux SMD 3535 Luminous Flux Binning and Forward Voltage Binning information.

Product Selection Guide

Table 2: Selection Guide, Pulsed Measurement Data at 700mA ($T_j = T_{sp} = 85^\circ\text{C}$)

Part Number ^{1,5}	Nominal CCT ² (K)	CRI ^{3,4}	Nominal Drive Current (mA)	Forward Voltage ⁴ (V)			Typical Pulsed Flux ⁴ (lm)	Typical Power (W)	Typical Efficacy (lm/W)
				Min	Typical	Max			
BXEX-27E-11H-3B1-00-0-0	2700	80	700	2.70	2.80	3.00	290	1.96	148
BXEX-30E-11H-3B1-00-0-0	3000	80	700	2.70	2.80	3.00	310	1.96	158
BXEX-35E-11H-3B1-00-0-0	3500	80	700	2.70	2.80	3.00	320	1.96	163
BXEX-40E-11H-3B1-00-0-0	4000	80	700	2.70	2.80	3.00	340	1.96	173
BXEX-50E-11H-3B1-00-0-0	5000	80	700	2.70	2.80	3.00	340	1.96	173
BXEX-57E-11H-3B1-00-0-0	5700	80	700	2.70	2.80	3.00	340	1.96	173
BXEX-65E-11H-3B1-00-0-0	6500	80	700	2.70	2.80	3.00	320	1.96	163

Notes for Table 2 :

1. The last 6 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and color bin.
Example: BXEX-57E-11H-3B1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 5700K 6-step ANSI standard chromaticity region with a minimum of 80 CRI, 1x1 die configuration, high power, 2.8V typical forward voltage.
2. Product CCT is not targeted at $T_{sp} = 85^\circ\text{C}$. Nominal CCT as defined by ANSI C78.377-2011.
3. Listed CRIs are minimum values and include test tolerance.
4. Products tested under pulsed condition (10ms pulse width) at nominal drive current.
5. Bridgelux maintains a $\pm 7.5\%$ tolerance on luminous flux measurements, $\pm 0.15\text{V}$ tolerance on forward voltage measurements, and ± 2 tolerance on CRI measurements for the SMD 3535.
6. Refer to Table 6 and Table 7 for Bridgelux SMD 3535 Luminous Flux Binning and Forward Voltage Binning information.

Performance at Commonly Used Drive Currents

SMD 3535 LEDs specifications at nominal drive current are shown in Table 1 and Table 2. SMD 3535 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current ¹ (mA)	Typical V_f $T_{sp} = 25^\circ\text{C}$ (V)	Typical Power $T_{sp} = 25^\circ\text{C}$ (W)	Typical Pulsed Flux ² $T_{sp} = 25^\circ\text{C}$ (lm)	Typical Pulsed Flux ³ $T_{sp} = 85^\circ\text{C}$ (lm)	Typical Efficacy $T_{sp} = 25^\circ\text{C}$ (lm/W)
BXEX-27E-11H-3B1-00-0-0	80	50	2.63	0.13	25	23	193
		350	2.77	0.97	169	153	174
		700	2.88	2.02	320	290	159
		840	2.92	2.46	376	341	153
		1100	2.99	3.29	476	431	144
		1400	3.07	4.30	582	527	135
		1800	3.17	5.70	713	646	125
BXEX-30E-11H-3B1-00-0-0	80	50	2.63	0.13	27	25	205
		350	2.77	0.97	179	164	185
		700	2.88	2.02	340	310	169
		840	2.92	2.46	400	364	163
		1100	2.99	3.29	505	461	153
		1400	3.07	4.30	618	564	144
		1800	3.17	5.70	758	691	133
BXEX-35E-11H-3B1-00-0-0	80	50	2.63	0.13	28	25	212
		350	2.77	0.97	185	169	191
		700	2.88	2.02	350	320	174
		840	2.92	2.46	411	376	167
		1100	2.99	3.29	520	476	158
		1400	3.07	4.30	636	582	148
		1800	3.17	5.70	780	713	137
BXEX-40E-11H-3B1-00-0-0 BXEX-50E-11H-3B1-00-0-0 BXEX-57E-11H-3B1-00-0-0	80	50	2.63	0.13	29	27	224
		350	2.77	0.97	195	179	202
		700	2.88	2.02	370	340	184
		840	2.92	2.46	435	400	177
		1100	2.99	3.29	550	505	167
		1400	3.07	4.30	673	618	157
		1800	3.17	5.70	824	758	145
BXEX-65E-11H-3B1-00-0-0	80	50	2.63	0.13	28	25	212
		350	2.77	0.97	185	169	191
		700	2.88	2.02	350	320	174
		840	2.92	2.46	411	376	167
		1100	2.99	3.29	520	476	158
		1400	3.07	4.30	636	582	148
		1800	3.17	5.70	780	713	137

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
2. Bridgelux maintains a $\pm 7.5\%$ tolerance on flux measurements.
3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Electrical and Thermal Characteristics

Table 4: Electrical and Thermal Characteristics

Part Number ¹	Drive Current (mA)	Forward Voltage ^{2,3} (V)			Typical Temperature Coefficient of Forward Voltage ⁴ $\Delta V_f / \Delta T$ (mV/°C)	Typical Thermal Resistance Junction to Solder Point ^{5,6} R_{j-sp} (°C/W)
		Minimum	Typical	Maximum		
BXEX-xxx-11H-3B1-00-0-0	700	2.70	2.80	3.0	-1.3	2.7

Notes for Table 4:

1. The last 6 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and color bin.
Example: BXEX-57E-11H-3B1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 5700K ANSI standard chromaticity region with a minimum of 80 CRI.
2. Products tested under pulsed condition (10ms pulse width) where $T_{sp} = 85^{\circ}\text{C}$.
3. Bridgelux maintains a tolerance of $\pm 0.1\text{V}$ on forward voltage measurements.
4. Products measured between 25°C and 105°C under pulsed condition (10ms pulse width).
5. Thermal Resistance values based on 5700K 80 CRI product.
6. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating
LED Junction Temperature (T_j)	150°C
Storage Temperature	-40°C to +105°C
Operating Solder Point Temperature (T_{sp})	-40°C to +105°C
Soldering Temperature	260°C or lower for a maximum of 40 seconds
DC Forward Current	1800mA
Reverse Voltage ²	-
Peak Pulse Forward Current ¹	2000mA
Moisture Sensitivity Rating	MSL ₃
Electrostatic Discharge	8kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012

Notes for Table 5:

1. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.
2. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. no rating is provided.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 3535 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 700mA, $T_{sp} = 85^{\circ}\text{C}$

Bin Code	Minimum	Maximum	Unit	Condition
D7	270	290	lm	$I_F = 700\text{mA}$
D8	290	310		
D9	310	330		
E6	330	350		
E7	350	370		

Note for Table 6:

1. Bridgelux maintains a tolerance of $\pm 7.5\%$ on luminous flux measurements.

Table 7: Forward Voltage Bin Definition at 700mA, $T_{sp} = 85^{\circ}\text{C}$

Bin Code	Minimum	Maximum	Unit	Condition
H	2.5	2.7	V	$I_F = 700\text{mA}$
J	2.7	2.9		
K	2.9	3.1		

Note for Table 7:

1. Bridgelux maintains a tolerance of $\pm 0.15\text{V}$ on forward voltage measurements.

Product Bin Definitions

Table 8: Color Bin Definition

2700K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.4578	0.4101	0.0081	0.0042	53.7		1	
6SDCM	0.4578	0.4101	0.0162	0.0084	53.7		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.4655	0.424	0.4501	0.3962	0.4471	0.4079	0.4687	0.4129
Point 2	0.4615	0.4169	0.4539	0.4031	0.4523	0.4087	0.4631	0.4112

3000K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.4338	0.403	0.00834	0.00408	53.22		1	
6SDCM	0.4338	0.403	0.01668	0.00816	53.22		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.4406	0.4172	0.4271	0.3888	0.4227	0.3993	0.445	0.4072
Point 2	0.4371	0.4099	0.4303	0.3957	0.4281	0.4008	0.4393	0.4048

3500K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.4078	0.393	0.00927	0.00414	54		1	
6SDCM	0.4078	0.393	0.01854	0.00828	54		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.4137	0.4084	0.4019	0.3776	0.3957	0.3873	0.42	0.3992
Point 2	0.4106	0.4006	0.4048	0.3852	0.4016	0.3899	0.4138	0.3958

4000K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.3818	0.3797	0.00939	0.00402	53.72		1	
6SDCM	0.3818	0.3797	0.01878	0.00804	53.72		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.3859	0.3942	0.3778	0.3652	0.3693	0.3722	0.3944	0.3877
Point 2	0.3837	0.3867	0.3797	0.3723	0.3754	0.3756	0.388	0.3834

Product Bin Definitions

Table 8: Color Bin Definition

5000K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.3447	0.3553	0.00822	0.00354	59.62		1	
6SDCM	0.3447	0.3553	0.01644	0.00708	59.62		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.3458	0.3675	0.3437	0.3431	0.3344	0.3473	0.355	0.3642
Point 2	0.3452	0.3612	0.3441	0.349	0.3394	0.3512	0.3497	0.3592

5700K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.3287	0.3417	0.00746	0.0032	59.09		1	
6SDCM	0.3287	0.3417	0.01492	0.0064	59.09		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.3287	0.3518	0.3288	0.3317	0.3194	0.335	0.3381	0.3499
Point 2	0.3287	0.3468	0.3287	0.3366	0.324	0.3383	0.3334	0.3451

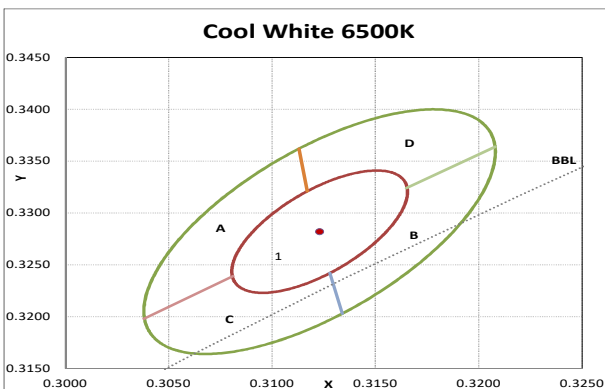
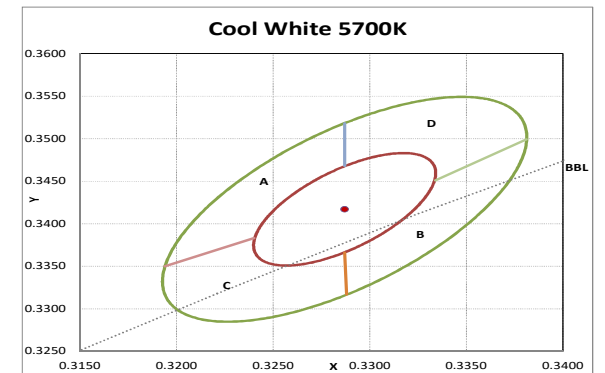
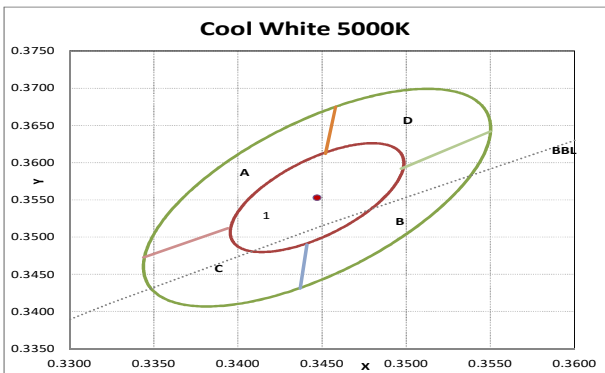
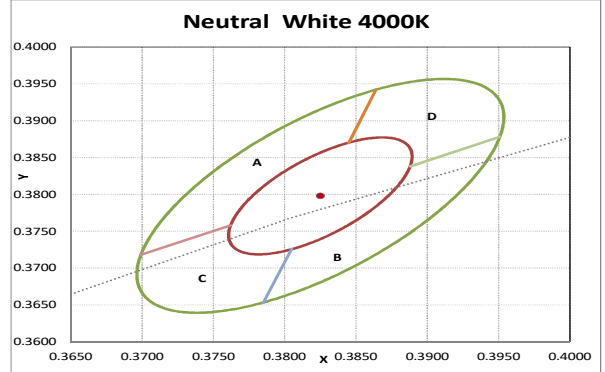
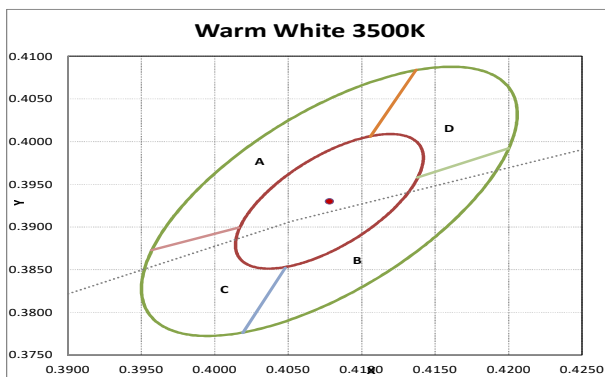
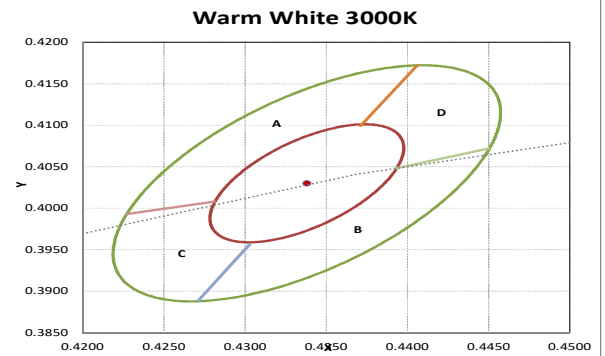
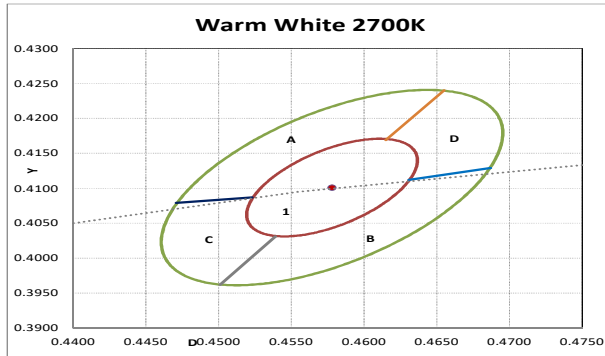
6500K	Center_x	Center_y	Major_Axis	Minor_Axis	Angle		Color Bin	
3SDCM	0.3123	0.3282	0.00669	0.00285	58.57		1	
6SDCM	0.3123	0.3282	0.01338	0.0057	58.57		A/B/C/D	
ITEM	A		B		C		D	
Point 1	0.3113	0.3362	0.3134	0.3203	0.3038	0.3198	0.3208	0.3364
Point 2	0.3117	0.3321	0.3128	0.3242	0.3081	0.3239	0.3165	0.3324

Note for Table 8:

1. Color binning at $T_{sp} = 85^{\circ}\text{C}$ unless otherwise specified
2. Bridgelux maintains a tolerance of ± 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (5 Color Bin Structure, Hot-color Targeted at $T_{sp}=85^{\circ}\text{C}$)



Performance Curves

Figure 2: Drive Current vs. Forward Voltage ($T_{sp}=85^{\circ}\text{C}$)

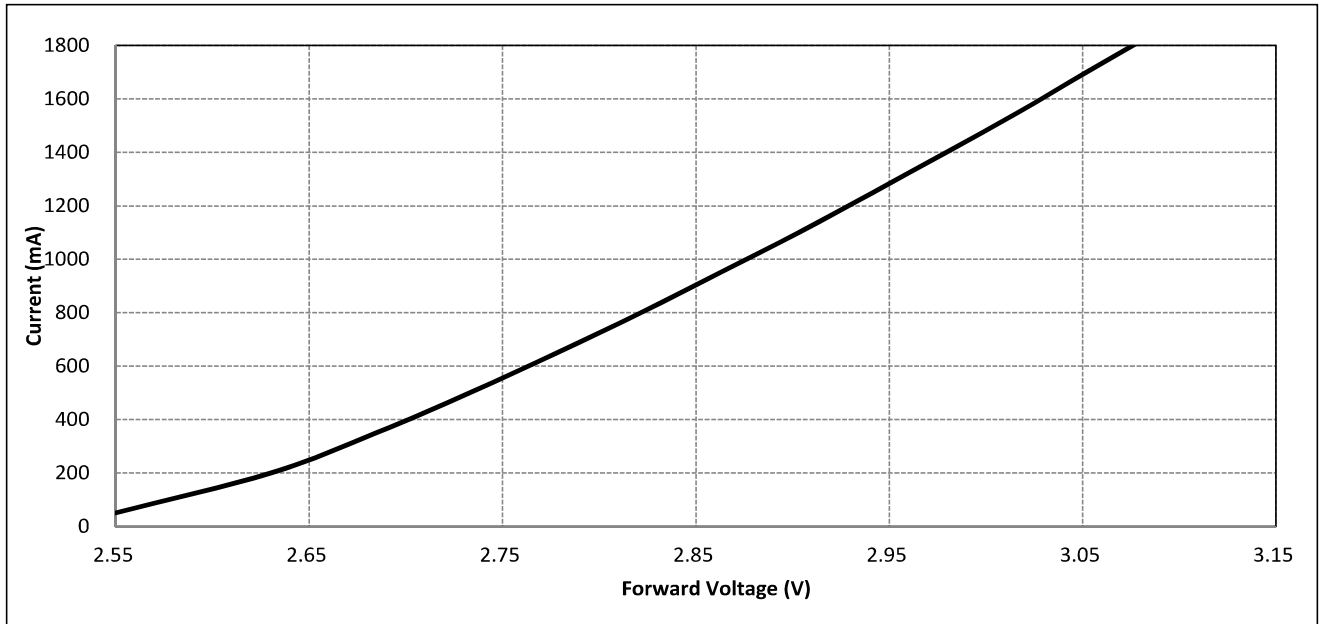
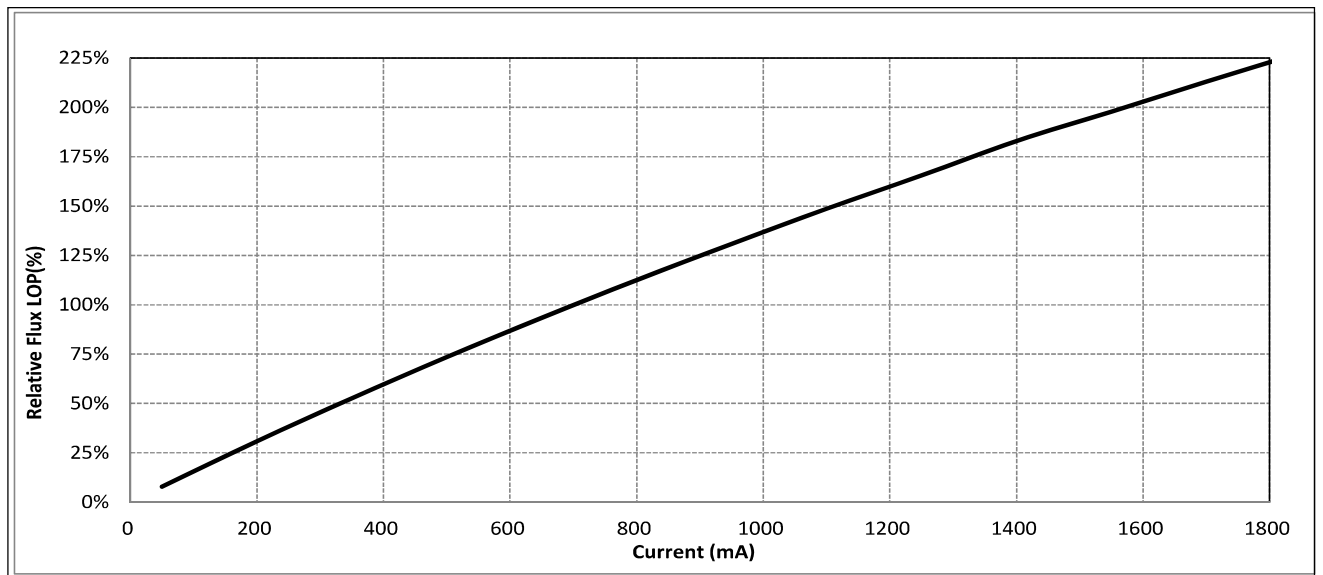


Figure 3: Typical Relative Luminous Flux vs. Drive Current ($T_{sp}=85^{\circ}\text{C}$)



Note for Figure 3:

1. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Typical Relative forward voltage vs. Solder Point Temperature_700mA

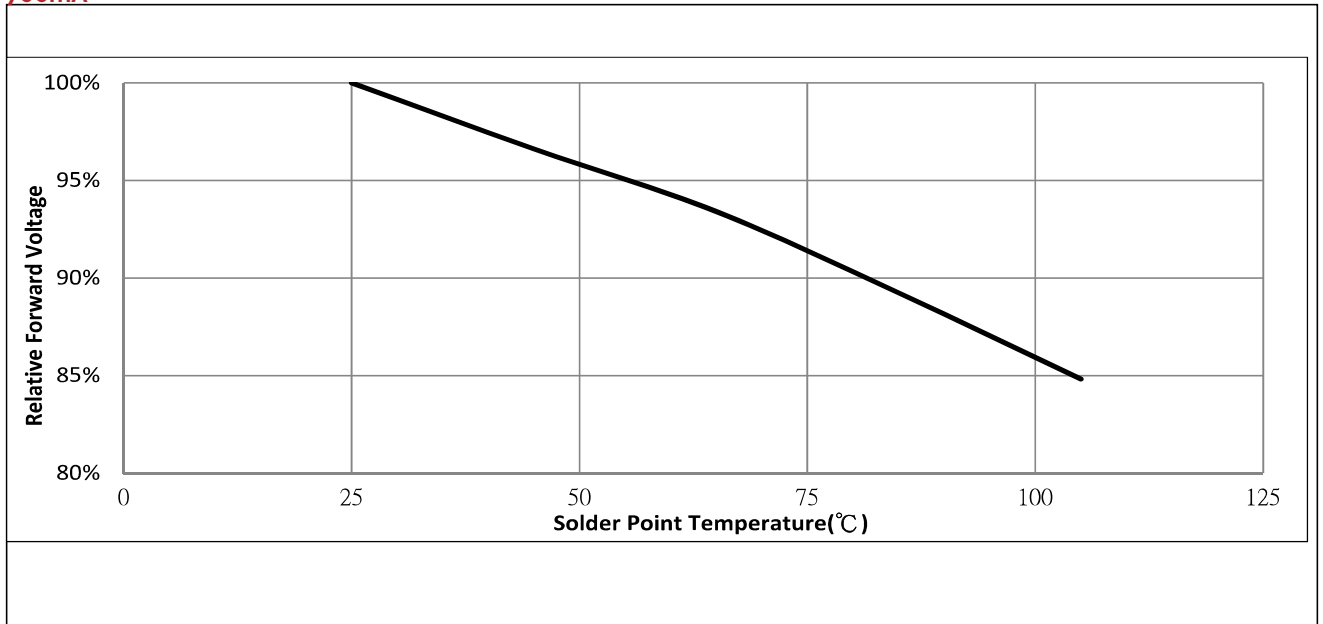
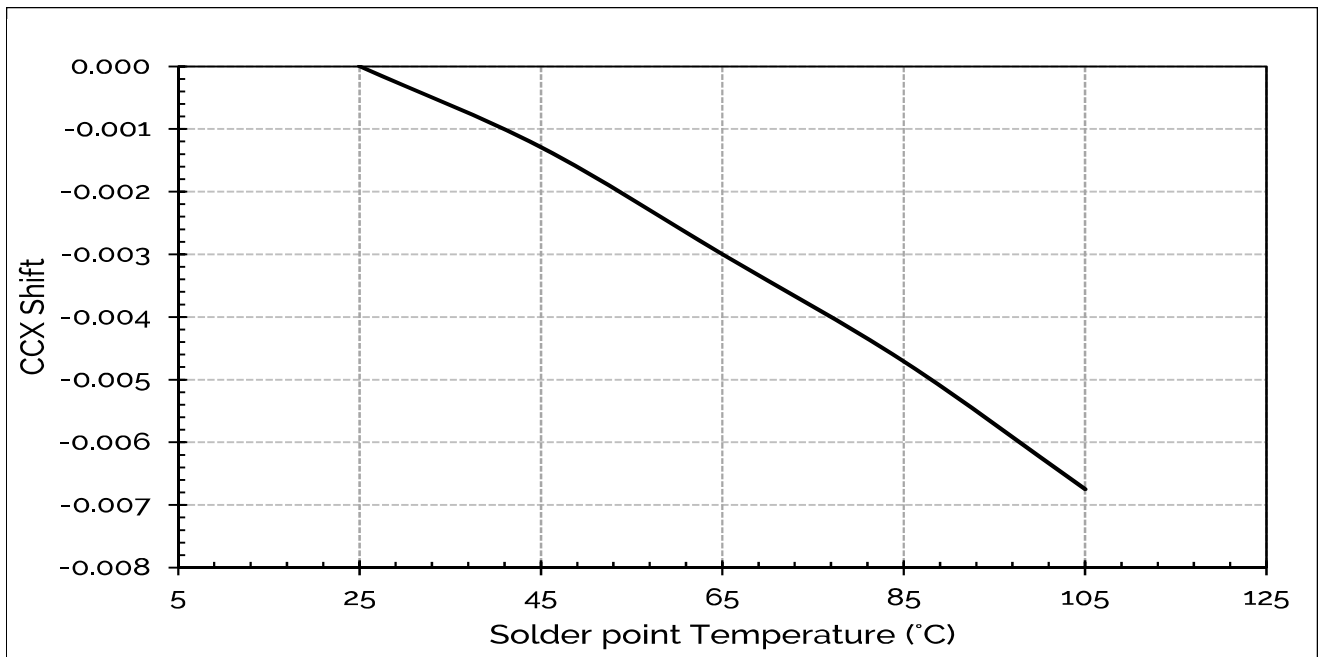


Figure 5: Typical CCX Shift vs. Solder Point Temperature_700mA

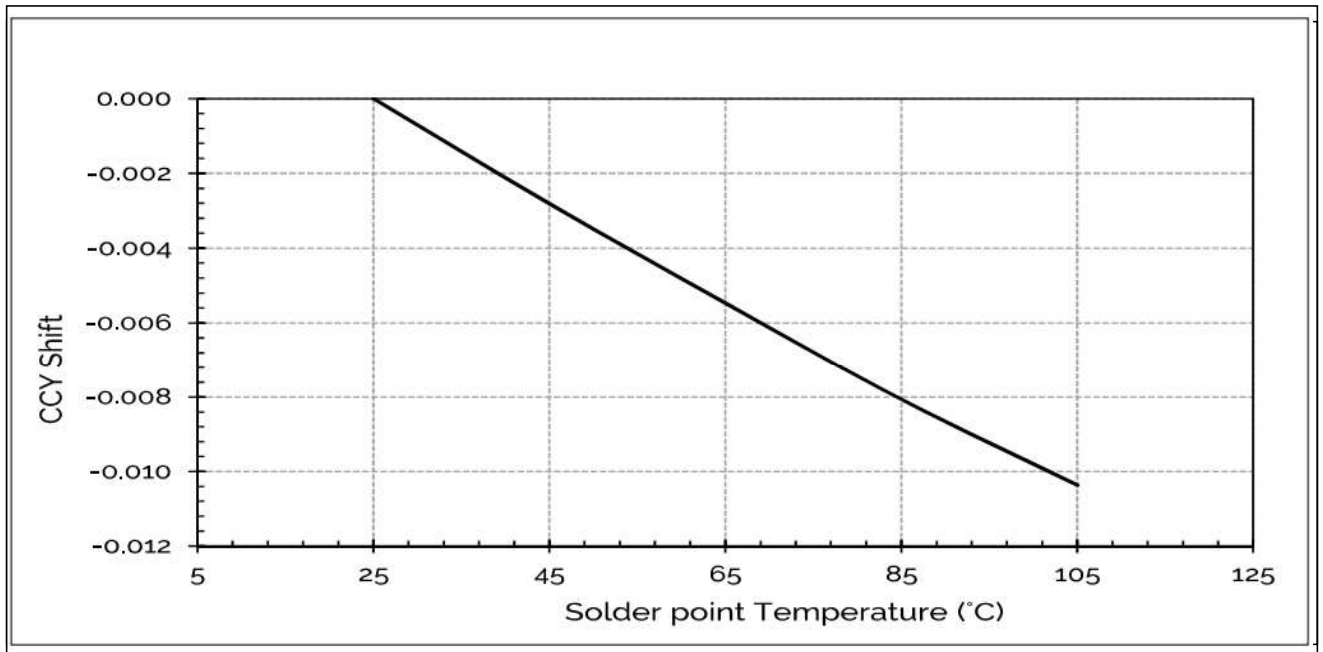


Notes for Figures 4 & 5:

1. Characteristics shown for cool white based on 5700K and 80 CRI.
2. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information

Performance Curves

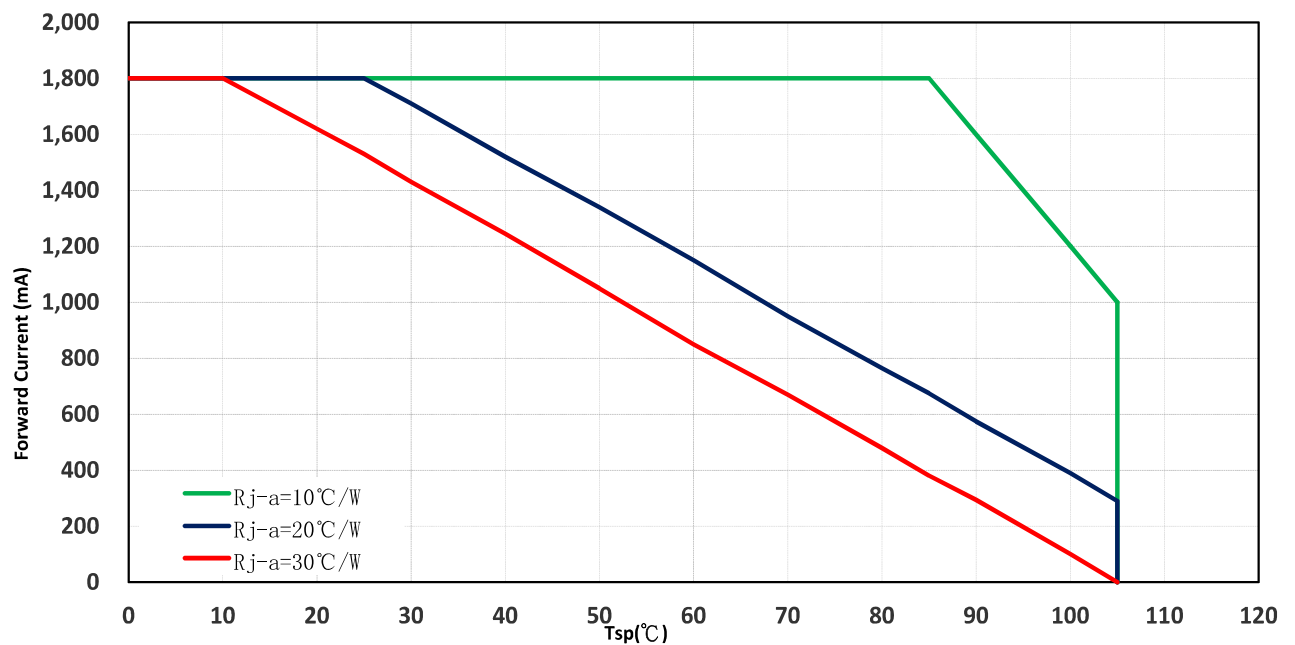
Figure 6: Typical CCY Shift vs. Solder Point Temperature_700mA



Notes for Figure 6:

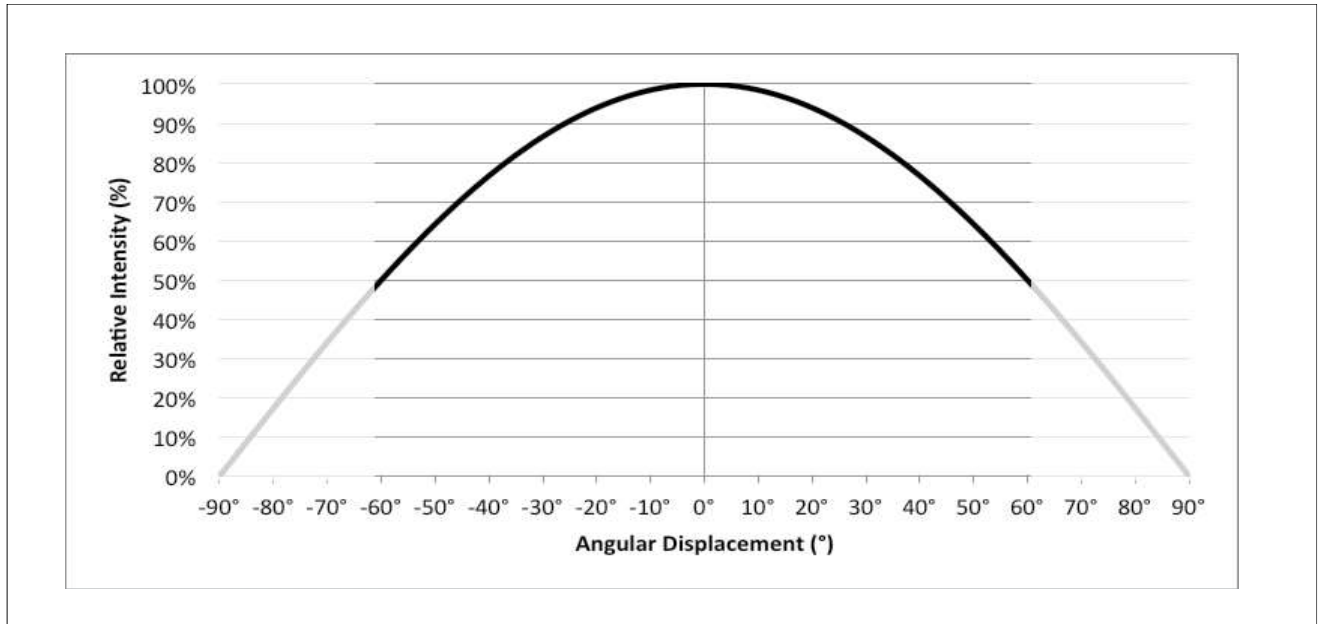
1. Characteristics shown for cool white based on 5700K and 80 CRI.
2. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information

Figure 7: Drive Current vs Solder Point Temperature



Typical Radiation Pattern

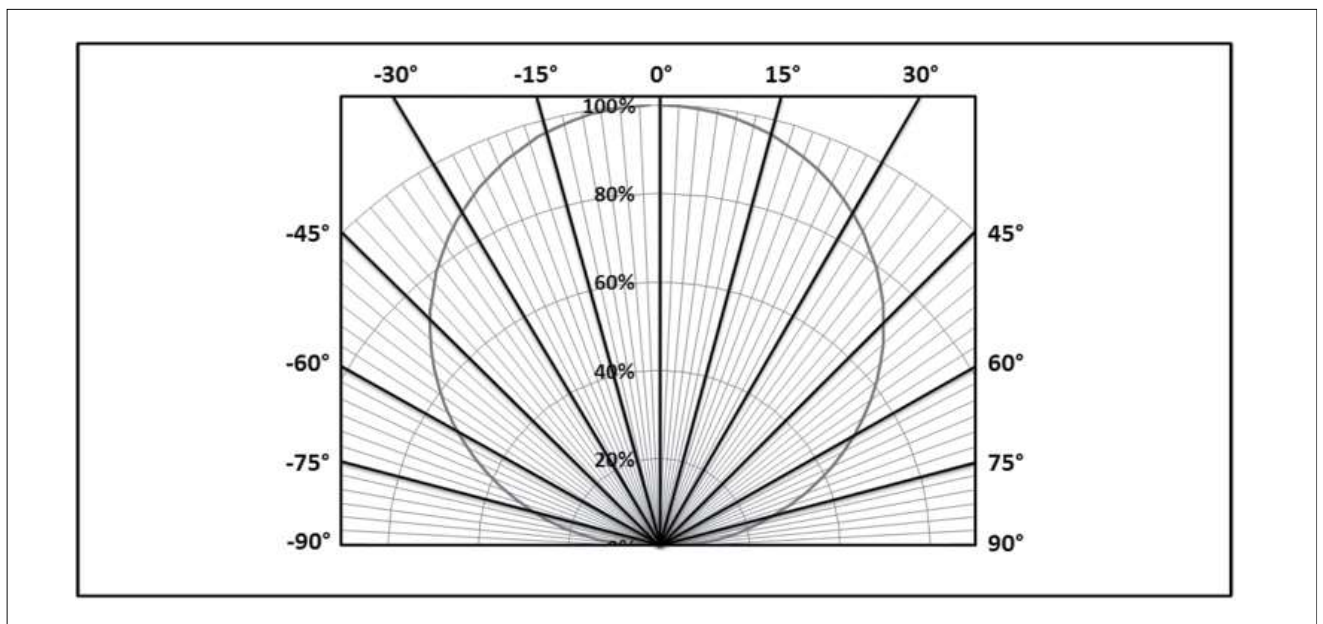
Figure 8: Typical Spatial Radiation Pattern at 700mA, $T_{sp}=25^{\circ}\text{C}$



Notes for Figure 8:

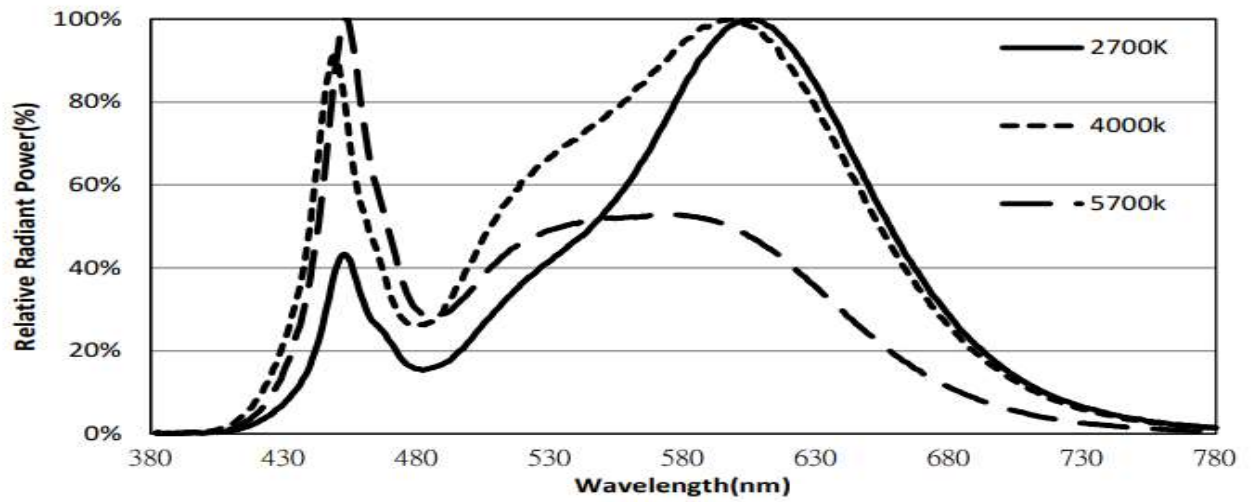
1. Typical viewing angle is 120° .
2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is $\frac{1}{2}$ of the peak value.

Figure 9: Typical Polar Radiation Pattern at 700mA, $T_{sp}=25^{\circ}\text{C}$



Typical Color Spectrum

Figure 10: Typical Color Spectrum

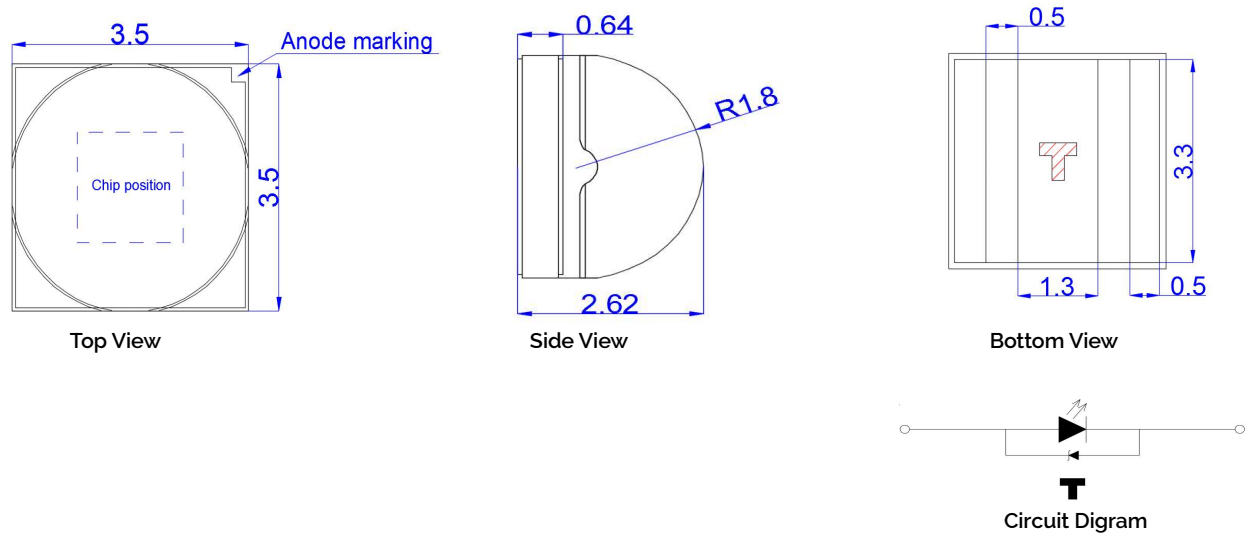


Notes for Figure 10:

1. Color spectra measured at nominal current for $T_{sp} = 85^{\circ}\text{C}$
2. Color spectra shown for 80 CRI products.

Mechanical Dimensions

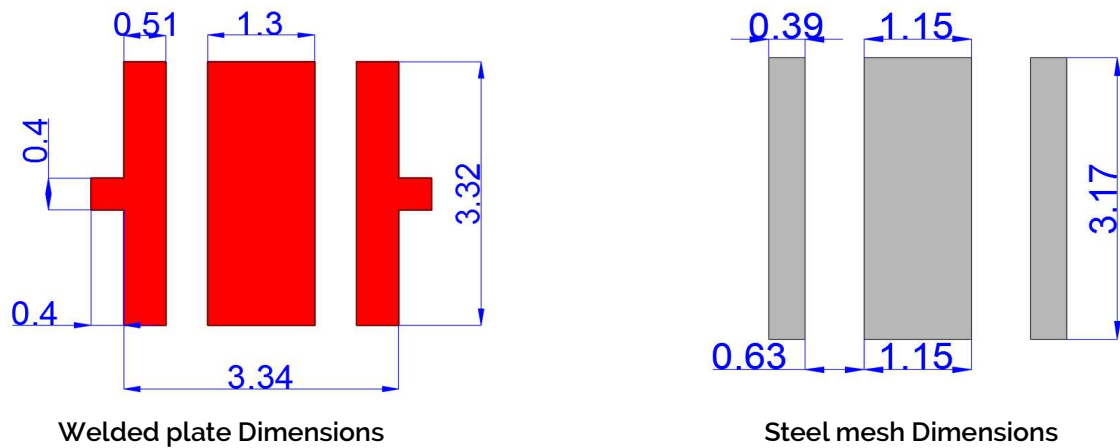
Figure 11: Drawing for SMD 3535



Notes for Figure 11:

1. Drawings are not to scale.
2. Drawing dimensions are in millimeters.
3. Unless otherwise specified, tolerances are $\pm 0.10\text{mm}$.

Welded plate and steel mesh Dimensions



Reliability

Table 9: Reliability Test Items and Conditions

No .	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/reflow Sensitivity	J-STD-020E	$T_{\text{slid}} = 260^{\circ}\text{C}$, 10sec, Precondition: 85°C , 60%RH, 168hr		3 reflows	0/20
2	Low Temperature Storage	JESD22-A119	$T_{\text{a}} = -40^{\circ}\text{C}$		1000 hours	0/20
3	High Temperature Storage	JESD22-A103D	$T_{\text{a}} = 105^{\circ}\text{C}$		1000 hours	0/20
4	Low Temperature Operating Life	JESD22-A108D	$T_{\text{a}} = -40^{\circ}\text{C}$	1800mA	1000 hours	0/20
5	Temperature Humidity Operating Life	JESD22-A101C	$T_{\text{sp}} = 85^{\circ}\text{C}$, RH=85%	1000mA	1000 hours	0/20
6	High Temperature Operating Life	JESD22-A108D	$T_{\text{sp}} = 85^{\circ}\text{C}$	1800mA	1000 hours	0/20
7	Thermal Shock	JESD22-A106B	$T_{\text{a}} = -40^{\circ}\text{C} \sim 125^{\circ}\text{C}$; Dwell : 15min; Transfer: 10sec		200 Cycle	0/20
8	Temperature Cycle	JESD22-A104E	$T_{\text{a}} = -40^{\circ}\text{C} \sim 100^{\circ}\text{C}$; Dwell at extreme temperature: 15min; Ramp rate $< 105^{\circ}\text{C}/\text{min}$		200 Cycle	0/20
9	Electrostatic Discharge	JS-001-2012	HBM, 8kV, 15k Ω , 100pF, Alternately positive or negative		pass	0/20

Passing Criteria

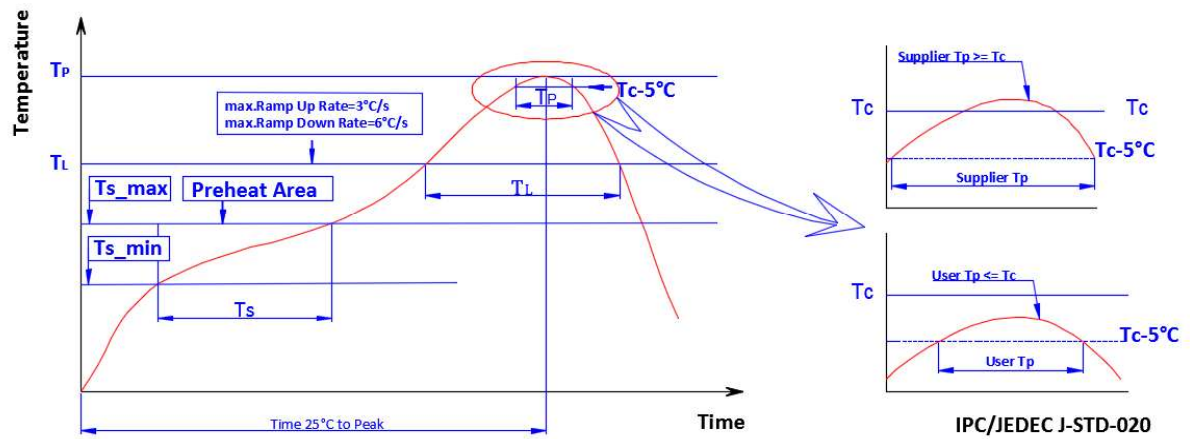
Item	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	700mA	$\Delta V_f < 10\%$
Luminous Flux	Fv	700mA	$\Delta F_v < 30\%$
Chromaticity Coordinates	(x, y)	700mA	$\Delta u'v' < 0.007$

Notes for Table 9:

- Measurements are performed after allowing the LEDs to return to room temperature
- T_{slid} : reflow soldering temperature; T_{a} : ambient temperature

Reflowing Characteristics

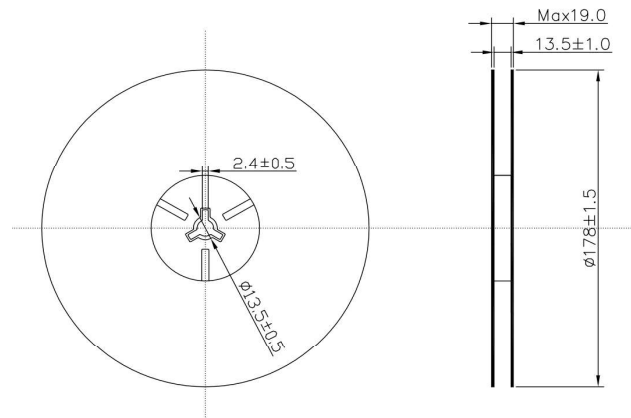
Figure 12 : Reflow Profile



Profile Feature	Lead Free Assembly
Temperature Min. (T_{s_min})	160°C
Temperature Max. (T_{s_max})	205°C
Time (ts) from T_{s_min} to T_{s_max}	60-150 seconds
Ramp-Up Rate (T_L to T_p)	3°C/second
Liquidus Temperature (T_L)	220°C
Time (T_L) Maintained Above T_L	60-150 seconds
Peak Temp(T_p)	260°C max.
Time (T_p) Within 5°C of the Specified Classification Temperature (T_c)	25 seconds max.
Ramp-Down Rate (T_p to T_L)	$5^\circ\text{C/second max.}$
Time 25°C to Peak Temperature	10 minutes max.

Packaging

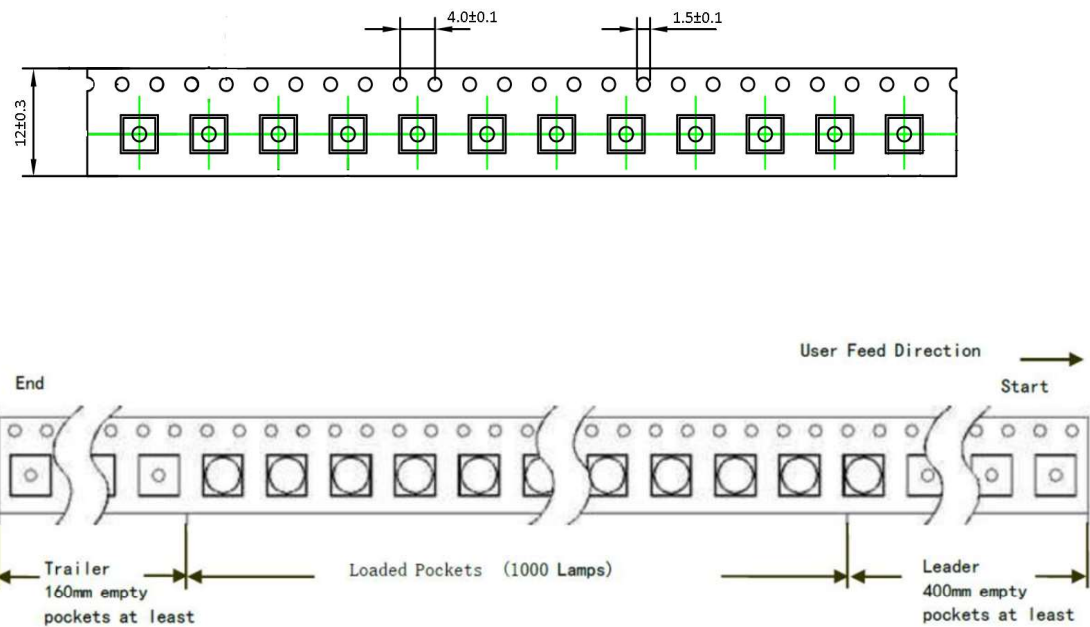
Figure 13: Emitter Reel Drawings



Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Emitter Tape Drawings



Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 15: Emitter Reel Packaging Drawings



Note for Figure 15:

1. Drawings are not to scale.

Design Resources

Optical Source Models

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux SMD LED emitter is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. SMD LED emitters are classified as Risk Group 2 when operated at or below the maximum drive current. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: Bridging Light and Life™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

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